Overview

HP Z2 Tower G4 Workstation

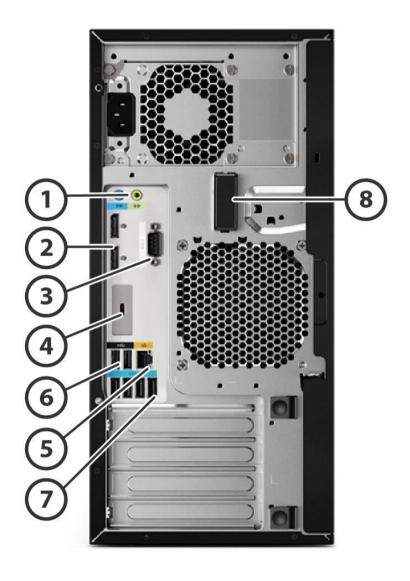


- 1. Power Button
- 2. Headphone/Microphone
- 3. 1 USB 3 port
- 4. 1 USB 3 Battery Charging Port
- 5. Optional Type-C Battery Charging Port

- 6. Optional SD Card Reader
- 7. External 5.25" bay

HP Z2 Tower G4 Workstation

Overview



- 1. 1 Audio Line In, 1 Audio Line Out,
- 2. 2 DisplayPort[™] (DP 1.2) output from Intel® UHD graphics (available on selected processors only)
- 3. Optional Serial Port
- 4. 1 flex IO module for 2nd LAN/VGA/HDMI/DP/USB Type-C/Thunderbolt™ 3.0 (Thunderbolt™ requires x4 PCIe Add in card)
- 5. RJ-45 to integrated GBe
- 6. 2 USB 2.0
- 7. 4 USB 3.0
- 8. Optional WLAN/BT Antenna



Overview

Form Factor Minitower

Operating Systems

Preinstalled:

- Windows 10 Home 64*
- Windows 10 Pro 64*
- Windows 10 Pro (National Academic License)*
- Windows 10 Pro for Workstations HP recommends Windows 10 Pro *
- HP Linux®-ready

Supported:

 Red Hat® Enterprise Linux® Workstation (1 year paper license available; Preinstall not available)

NOTE: For detailed OS/hardware support information for Linux, see: http://www.hp.com/support/linux_hardware_matrix

Processors

Name	Cores	Clock Speed (GHz)	Intel® Turbo Boost Technology³	Cache (MB)	Memory Speed (MT/s)	Hyper- Threading	Integrated Graphics	Featuring Intel® vPro™ Technology⁴	16GB Intel® Optane™ memory²,*	TDP (W)
Intel® Xeon® processor E-2176G¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics	Y	N	80W
Intel® Xeon® processor E-2174G¹	4	3.8	4.7	8	2666	Y	Intel® UHD Graphics	Y	N	71W
Intel® Xeon® processor E-2144G¹	4	3.6	4.5	8	2666	Y	Intel® UHD Graphics	Y	N	71W
Intel® Xeon® processor E-2136¹	6	3.3	4.5	12	2666	Y	N/A	Y	N	80W
Intel® Xeon® processor E-2126G¹	6	3.3	4.5	12	2666	N	Intel® UHD Graphics	Y	N	80W
Intel® Xeon® processor E-2124G¹	4	3.4	4.3	8	2666	N	Intel® UHD Graphics	Υ	N	71W
Intel® Xeon® processor E-2104G¹	4	3.2	N/A	8	2666	N	Intel® UHD Graphics	Y	N	65W
Intel® Core™ i7-8700K processor¹	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics	Υ	N	95W
Intel® Core [™] i7+8700K processor (Core i7 and 16GB Intel® Optane [™] memory) ^{1,2,*}	6	3.7	4.7	12	2666	Y	Intel® UHD Graphics 630	Y	Y	95W
Intel® Core™ i7-8700 processor¹	6	3.2	4.6	12	2666	Υ	Intel® UHD Graphics	Y	N	65W

^{*} Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

Overview

Intel® Core [™] i7+8700 processor (Core i7 and 16GB Intel® Optane [™] memory) ^{1,2,*}	6	3.2	4.6	12	2666	Y	Intel® UHD Graphics 630	Υ	Y	65W
Intel® Core™ i5-8600 processor¹	6	3.1	4.2	9	2666	N	Intel® UHD Graphics	Υ	N	65W
Intel® Core™ i5+8600 processor (Core i5 and 16GB Intel® Optane™ memory) 1,2,*	6	3.1	4.2	9	2666	N	Intel® UHD Graphics 630	Υ	Y	65W
Intel® Core™ i5-8500 processor¹	6	3.0	4.0	9	2666	N	Intel® UHD Graphics	Υ	N	65W
Intel® Core [™] i5+8500 processor (Core i5 and 16GB Intel® Optane [™] memory) ^{1,2,*}	6	3.0	4.0	9	2666	N	Intel® UHD Graphics 630	Υ	Y	65W
Intel® Core™ i3-8100 processor¹	4	3.6	N/A	6	2400	N	Intel® UHD Graphics	N	N	65W
Intel® Pentium™ G5400 processor¹	2	3.7	N/A	4	2400	Υ	Intel® UHD Graphics	N	N	54W

¹Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

²Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

*16GB Intel® Optane™ memory Available Fall 2018

³The specifications shown in the Intel® Turbo Boost Technology column represent the maximum turbo frequency with one core active. Turbo boost stepping occurs in 100MHz increments. Processors that do not have turbo functionality are denoted as N/A. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.

⁴vPro. Some functionality of this technology, such as Intel® Active management technology and Intel® Virtualization technology, requires additional 3rd party software in order to run. Availability of future "virtual appliances" applications for Intel vPro technology is dependent on third-party software providers. Compatibility of this generation of Intel vPro technology-based hardware with future "virtual appliances" is yet to be determined.

NOTES

Integrated Intel® UHD graphics P630 is supported on the select Intel® Xeon E processors.

Intel® Xeon® E, Intel® Core™ i3 and Intel® Pentium processors can support either ECC or non-ECC memory; Intel® Core i5/i7 processors only support non-ECC memory.

Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.

NOTE: In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

Overview

Color Black

Expansion Slots (see

1 PCIe Gen3 x16 slot

more details)

system board section for 1 PCIe Gen3 x4 slot /x16 connector 1 PCIe Gen3 x1 slot/x4 connector 1 PCIe Gen3 x1 slot/x4 connector 2 M.2 storage (PCIe Gen3 x4)* 1 M.2 Wlan (PCIe Gen3 x1+ intel CNVI)*

> **NOTE:** The PCIe Gen 3 x16 slot is meant for HP qualified cards, configured or after market. HP does not provide warranty support for 3rd party cards.

* M.2 storage supports compatible devices at 80mm

Expansion Bavs (see

2 external Half Height 5.25" Bays

storage section for more 2 internal 3.5" Drive Bays

details)

Front I/O 1 USB 3.0, 1 USB 3.0 Charging Data Port, 1 Headphone/Microphone. 1 USB3.1 Gen2 Type-C Charging

Data Port (Optional), 1 SD Card Reader (Optional).

Internal I/O 1 USB 3.0 and 3 USB 2.0 ports available as 2 separate 2x10 (3.0 x1, 2.0 x1) and 2x5 (2.0 x2) header:

supports one USB 3.0 Media Card Reader.

Rear I/O 2 DisplayPort™ (DP 1.2) outputs from Intel® UHD Graphics (available on specific processors only); 4 USB

> 3.0 ports, 2 USB 2.0 ports, 1 serial port (optional), 1 parallel port (optional), 2 PS/2 (optional), RJ-45 (LoM), 1 Flex IO port (3rd DisplayPortTM/HDMI/VGA/2nd 1GbE LAN/ USB-C 3.1 Gen2 Charging Data

Port/Thunderbolt™ 3.0-Thunderbolt™ 3.0 PCIe card utilizes Flex IO option)

, (1 Audio Line-in, and 1 Audio Line-out.

Interfaces Supported

SD Media Card Reader (optional) Type-C Battery Charging Port (optional)

WxD)

Chassis Dimensions (H x Standard minitower orientation: 356 mm x 169 mm x 435 mm (14.0 x 6.7 x 17.1 in)

Weight Exact weights depend upon configuration:

> Minimum: 7.0 kg (15.43 lb) Typical*: 8.2 kg (18.03 lb) Maximum: 11.4 kg (25.18 lb)

Supported Weight (desktop orientation): 35 kg (77 lb)

Packaging (H x W x D): 599 x499 x 295 mm(23.58 x 19.65 x 11.6 in)

Shipping Weight: 11.47 kg(25.26 lb)

 st Typical weight when configured with st 3.5" hard drives, 1 optical drive, 2 DIMMs and 1 NVIDIA st

Quadro® P1000 graphics card

500W wide-ranging, active Power Factor Correction, 90 Efficient **Power Supply**

250W 85% Efficiency wide-ranging, active PFC Power Supply option.

Backup Devices For a complete listing of compatible DAT tape drives, LTO tape drives and RDX Removable Disk Backup

System offerings, please visit http://www.hp.com/go/connect

Overview

Chipset Intel® C246 chipset

Memory 4 DIMM slots, supporting up to 64GB ECC/non-ECC, DDR4 2666 MT/s speed depending on the CPU

selection.



Supported Components

Processors		Factory Configured	Option Kit
	Intel® Xeon® processor E-2100 family ²		
	Intel® Xeon® processor E-2176G	Υ	N
	Intel® Xeon® processor E-2174G	Υ	N
	Intel® Xeon® processor E-2144G	Υ	N
	Intel® Xeon® processor E-2136	Υ	N
	Intel® Xeon® processor E-2126G	Υ	N
	Intel® Xeon® processor E-2124G	Υ	N
	Intel® Xeon® processor E-2104G	Υ	N
	8th generation Intel® Core™ processor family³		
	Intel® Core™ i7-8700K 3.7 2666 6C CPU	Υ	N
	Intel® Core™ i7+8700K (Core i7 and 16GB Intel® Optane™ memory*) 3.7 2666 6C CPU	Υ	N
	Intel® Core™ i7-8700 3.2 26666 6C CPU	Υ	N
	Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory*) 3.2 26666 6C CPU	Υ	N
	Intel® Core™ i5-8600 3.1 2666 6C CPU	Υ	N
	Intel® Core™ i5+8600 (Core i5 and 16GB Intel® Optane™ memory*) 3.1 2666 6C CPU	Υ	N
	Intel® Core™ i5-8500 3.0 2666 6C CPU	Υ	N
	Intel® Core™ i5+8500 (Core i5 and 16GB Intel® Optane™ memory*) 3.0 2666 6C CPU	Υ	N
	8th generation Intel® Core™ i3/Pentium processor family²		
	Intel® Core™ i3-8100 3.6 2400 4C CPU	Υ	N
	Intel® Pentium® G5400 3.7 2400 2C CPU	Υ	N

NOTE 1: Intel® Integrated P630 Graphics for select Xeon E processors supports workstation-specific graphics drivers for improved compatibility and performance on select professional applications, compared to Intel® UHD Graphics 630.

NOTE 2: These processors support either ECC or non-ECC memory

NOTE 3: These processors support only non-ECC memory

NOTE 4: Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system.

*16GB Intel® Optane™ memory Available Fall 2018

Monitors / Displays		Factory Configured	Option Kit	Option Kit Part Number
	HP Z Display Z27n G2 27-inch IPS LED Backlit Monitor		Y	1JS10AA
	HP Z Display Z24n G2 24-inch IPS LED Backlit Monitor		Y	1JS09AA
	HP Z Display Z24nf G2 23.8-inch IPS Backlit Monitor		Y	1JS07AA
	HP Z Display Z23n G2 23-inch IPS LED Backlit Monitor		Y	1JS06AA
	HP Z Display Z22n G2 21.5-inch IPS LED Backlit Monitor		Y	1JS05AA
	Supported by all Operating Systems available from HP Screen Size Diagonally Measured			



Supported Components

SATA Hard Drives		Factory Configured	Option Kit	Option Kit Part Number
	500GB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ036AA
	1TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	LQ037AA
	2TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	QB576AA
	4TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	K4T76AA
	6TB SATA 7200 rpm 6Gb/s 3.5" HDD	Υ	Υ	3DH90AA
	500GB SATA 7.2K SED SFF HDD	Υ	N	(N/A as AMO)
	1TB SATA 7200 rpm 8GB 3.5" SSHD (hybrid)	Υ	Υ	M7S54AA
SATA Solid State Drives	HP 256GB SATA 6Gb/s SSD	Υ	Υ	A3D26AA
	HP 512GB SATA 6Gb/s SSD	Υ	Υ	D8F30AA
	HP 1TB SATA 6Gb/s SSD	Υ	Υ	F3C96AA
	HP 2TB SATA 6Gb/s SSD	Υ	Υ	Y6P08AA
	HP 256GB SATA 6Gb/s SED Opal 2 SSD	Υ	Υ	G7U67AA
	HP Enterprise Class 240GB SATA SSD	Υ	Υ	T3U07AA
	HP Enterprise Class 480GB SATA SSD	Υ	Υ	T3U08AA
	16GB Intel® Optane™ memory*,**	Υ	Υ	TDB

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

PCIe SSDs PCIe SSDs for HP Workstations

HP Z Turbo Drv G2 1TB TLC PCIe SSD **	Υ	Υ	Y1T53AA
HP Z Turbo Drv G2 256GB TLC PCIe SSD **	Υ	Υ	Note 1
HP Z Turbo Drv G2 512GB TLC PCIe SSD **	Υ	Υ	Note 1
Intel® 905p Series SSD (Opatane SSD)			
Intel® Optane SSD 905p 280GB AiC*,***	Υ	Υ	2SC47AA
Intel® Optane SSD 905p 480GB AiC*,***	Υ	Υ	2SC48AA

^{*} PCIe card installed in standard PCIe x4 slot

NOTE: For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB (for Windows 10) of system disk is reserved for system recovery software.

^{**16}GB Intel® Optane™ memory Available Fall 2018

^{**} Installed in native M.2 storage slot Z2 G4

^{***} Intel® Optane SSD Available Fall 2018

Supported Components

NOTE: The HP Z2 Tower G4 Workstation is capable of configuring up to 2 Z Turbo Drives. By default, the Z Turbo Drive configured will be installed in the M.2 storage slot on the system's motherboard.

Hard Drive Controllers		Factory		
		Configured	Option Kit	
	Integrated SATA Controller (Z2 G4)			
	Integrated SATA Controller, RAID 0,1 supported: 4x 6 Gb/s ports	Υ	N	
	Factory integrated RAID on motherboard for SATA drives			
	RAID 0 Data Configuration	Υ	N	
	RAID 1 Data Configuration	Υ	N	
	Factory integrated RAID on motherboard for Z Turbo Drive			
	RAID 0 Boot or Data Configuration	Υ	N	
	RAID 1 Boot or Data Configuration	Υ	N	

NOTE: SATA hardware RAID is not supported on Linux® systems. The Linux® kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. All drives must be identical in type and capacity. Boot volume/RAID array must be less than 2 TB

NOTE 1: Requires identical drives (speeds, capacity, and interface).

Graphics		Factory				rted
		Configured	Option Kit	Option Kit Part Number	# of cards	Mixed?
	Integrated Intel® ∪HD Graphics Me	dia Accelerat	ors (Z2 G4)			
	Intel® UHD Graphics P630	Υ	N		1	
	Intel® UHD Graphics 630	Υ	N		1	
	Intel® UHD Graphics 610	Υ	N		1	
	Graphics Cable Adapters					
	HP DisplayPort™ to Dual Link DVI Adapter	N	Υ	NR078AA	1	
	HP DisplayPort™ To DVI-D Adapter (4-Pack)	N	N		1	
	HP DisplayPort™ To DVI-D Adapter (2-Pack)	Y	N		1	
	HP DisplayPort™ To DVI-D Adapter	Υ	Υ	FH973AA	1	
	HP DisplayPort™ To VGA Adapter	Υ	Υ	AS615AA	1	
	HP Display to HDMI Adapter	N	Υ			
	HP miniDP to DP Adapter	N	Υ			
	HP USB-C to VGA Adapter	N	Υ			
	HP USB-C to HDMI Adapter	N	Υ			
	HP USB-C to DP Adapter	N	Υ			
	·					

Entry 3D



Supported Components

Υ	Υ	2TF08AA	2
Υ	Υ	1ME43AA	2
Υ	Υ	3ME25AA	1
N	Υ	ZOB15AA	1
Υ	Y	1ME01AA	2
Υ	Υ	1ME41AA	1
Υ	Υ	ZOB14AA	1
Υ	Υ	1ME40AA	1
Υ	Υ	1ME40AA	1
	Y Y N Y Y	Y Y Y Y Y Y Y Y Y Y	Y Y 1ME43AA Y Y 3ME25AA N Y ZOB15AA Y Y 1ME01AA Y Y 1ME41AA Y Y ZOB14AA Y Y 1ME40AA

^{*} Requires 500W PSU. Not supported with 250W PSU.

NOTE 1: Intermixing integrated Intel® UHD graphics and discrete graphics cards in order to drive more than three displays can be enabled using the Computer (F10) Setup Utility. However, HP recommends using only discrete graphics when four or more displays are required to be supported.

Memory DDR4-2666 ECC Unbuffered DIMMs - CTO

8GB DDR4-2666 ECC (1x8GB) RAM 16GB DDR4-2666 ECC (2x8GB) RAM 32GB DDR4-2666 ECC (4x8GB) RAM 32GB DDR4-2666 ECC (2x16GB) RAM

64GB DDR4-2666 ECC (4x16GB) RAM

DDR4-2666 non-ECC Unbuffered DIMMs - CTO

4GB DDR4-2666 nECC (1x4GB) RAM

8GB DDR4-2666 nECC (2x4GB) RAM

8GB DDR4-2666 nECC (1x8GB) RAM

16GB DDR4-2666 nECC (2x8GB) RAM

32GB DDR4-2666 nECC (2x16GB) RAM

32GB DDR4-2666 nECC (4x8GB) RAM

64GB DDR4-2666 nECC (4x16GB) RAM

NOTES:



Supported Components

Intel® Xeon E, Intel® Core™ i3 and Intel® Pentium processors can support either ECC or non-ECC memory; Intel® Core™ i5/i7 processors only support non-ECC memory.

Two channels of DDR4 memory are supported. To realize full performance at least one DIMM must be inserted into each channel.

Max transfer rates up to 2666 MT/s

NOTE: Only unbuffered DDR4 DIMMs are supported.

AMO	Option Kit Part Number
DDR4-2666 ECC Unbuffered DIMMs – AMO	
HP 8GB (1x8GB) DDR4-2666 ECC Unbuffered RAM	3TQ39AA
HP 16GB (1x16GB) DDR4-2666 ECC Unbuffered RAM	3TQ40AA
DDR4-2666 non-ECC Unbuffered DIMMs – AMO	
HP 4GB (1x4GB) DDR4-2666 nECC Unbuffered RAM	3TQ31AA
HP 8GB (1x8GB) DDR4-2666 nECC Unbuffered RAM	3PL81AA
16GB (1x16GB) DDR4-2666 nECC Unbuffered RAM	3PL82AA

The CPUs determine the speed at which the memory is clocked. If a 2400 MHz capable CPU is used in the system, the maximum speed the memory will run at is 2400 MHz regardless of the specified speed of the memory.

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	
	Integrated Conexant CX20632 5.1 HDA codec	Υ	N		
Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	
	HP 9.5mm Slim DVD Writer	Υ	Υ	K3R64AA	
	HP 9.5mm Slim DVD-ROM Drive	Υ	Υ	K3R63AA	
	HP 9.5mm Slim BDXL Blu-Ray Writer	Υ	Υ	K3R65AA	
	HP SD Media Card Reader	Υ	Υ		
	HDD Frame/Carriers				
	HP DX175 Removable HDD Carrier	N	Υ	1ZX72AA	
	HP DX175 Removable HDD Frame/Carrier	N	Υ	1ZX71AA	
	And the second control of the second control of the second		DVD		

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. With Blu-ray, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

Supported Components

Controller Cards	Factory	Factory	
	Configured	Option Kit	Number
HP Thunderbolt™ 3 PCIe 3-port I/O Card	Υ	Υ	4CX35AA
NOTE 1: Utilizes Flex IO port connection for flex po	ort		

Networking and Communications		Factory Configured	Option Kit	Option Kit Part Number
	Integrated Intel® 1219LM PCIe GbE Controller (Intel® vPro™ with Intel® AMT 12.0)	Υ	N	
	Intel® X710-DA2 2-Port 10GbE SFP+ NIC	Υ	Υ	1QL47AA
	HP 10GbE SFP+ SR Transceiver	Υ	Υ	C3N53AA
	Intel® X550-T2 2-Port 10GbE NIC	Υ	Υ	1QL46AA
	Intel® 9560 802.11 a/b/g/n/ac with Bluetooth® 5 M.2	Υ	N	
	Intel® I350-T2 2-Port 1GbE(3) NIC	Υ	Υ	V4A91AA
	Intel® I350-T4 4-Port 1GbE(3) NIC	Υ	Υ	W8X25AA
	Aquantia AQN-108 1-Port 5GbE NIC	Υ	Υ	1PM63AA

NOTE 1: The integrated network connection is required to support Intel® vPro™ Technology.

NOTE 2: If AMT is provisioned, then network teaming with the integrated LAN port is not possible.

NOTE 3: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number
	Kensington Lock	N	Υ	
	HP Z2 Mini Sleeve	N	Υ	3RW68AA
	HP Z4/6 Depth Adjustable Fixed Rail Rack Kit	N	Υ	2HW42AA
	HP Solenoid Lock and Hood (TWR) Sensor	Υ	Υ	E0X96AA
	HP Business PC Security Lock Kit	N	Υ	PV606AA
	HP UltraSlim Cable Lock Kit	N	Υ	T1A62AA

Supported Components

Input Devices		Factory Configured	Option Kit	Option Kit Part Number
	HP USB Optical Mouse	Υ	Υ	QY777AA
	HP PS/2 Mouse	N	Y	QY775AA
	HP USB Hardened Mouse	Y	Y	P1N77AA
	HP USB Premium Mouse	Ϋ́	Ϋ́	
	HP Premium Wireless Mouse	Υ	Υ	
	SpaceMouse Pro USB 3D Input Device	N	Υ	
	3Dconnexion CADMouse	N	Y	M5C35AA
	HP USB Business Slim CCID SmartCard Keyboard	Υ	Υ	
	HP USB Business Slim Keyboard	Υ	Υ	N3R87AA
	HP PS/2 Business Slim Keyboard	N	Υ	
	HP USB Premium Keyboard	Y	Ϋ́	N3R86AA
	HP Premium Wireless Keyboard	Υ	Υ	
	HP Wireless Business Slim Keyboard & Mouse	Y	Υ	
Other Hardware		Factory Configured	Option Kit	Option Kit Part Number
	HP Power Cord Kit	N	Υ	DM293A
	HP Workstation Mouse Pad (Japan only)	Υ	N	
	HP Serial Port Adapter	Υ	Υ	1VD82AA
	HP Serial + PS/2 Adapter	Υ	Υ	
	HP ENERGY STAR® Certified Configuration	Υ	N	
	HP Internal USB Port Kit	N	Υ	EM165AA
	HP eSATA PCI Cable Kit	Υ	Υ	FH966AA
	HP Z2 Tower G4 Bezel w/ Dust Filter option	N	Υ	4KY89AA
	HP PCIe x1 Parallel Port Card	N	Υ	N1M40AA
	Z2 Tower G4 Dust Filter (filter only)	N	Υ	3TQ24AA
	HP Z2 G4 TWR Front Card Guide Kit	Υ	Υ	4KY82AA
Flex Module (Rear IO)		Factory Configured	Option Kit	
	HP Flex IO module (VGA)	Υ	N	3TK80AA
	HP Flex IO module (HDMI)	Υ	N	3TK74AA
	HP Flex IO module (DP)	Υ	N	3TK72AA
	HP Flex IO module (USB-C)	Υ	N	4KY84AA
	HP Flex IO module (1 Gbe LAN)	Υ	N	3TQ26AA
Software		Factory Configured	Option Kit	Support Notes
	HP Performance Advisor	Υ	N	Note 1
	HP Remote Graphics Software (RGS) 7.x	Υ	N	
	HP PC Hardware Diagnostics UEFI	Υ	N	Note 2
	NOTE 1: Supports, and preinstalled with Windows 10 only http://www.hp.com/go/performanceadvisor NOTE 2: Windows OS only	y. Also available as a	a free downlo	ad from



Supported Components

Operating Systems Windows 10

Windows 10 Pro 64

Windows 10 Pro (National Academic License)

Windows 10 Pro for Workstations – HP recommends Windows 10 Pro Red Hat® Enterprise Linux® (RHEL) Workstation – Paper License (1yr)

NOTE: For detailed OS/hardware support information for Linux, see:

http://www.hp.com/support/linux_hardware_matrix http://www.microsoft.com/windows/windows-7/



Supported Components

HP BIOS

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate
 the HP Z2 G4 Workstation into the enterprise, such as PXE, remote recovery, remote
 configuration, remote control, and BIOS (F10) Setup support for 14 languages.
- Network firmware updates Update your BIOS via the cloud or standardize on a BIOS version hosted on an Enterprise network.
- Stability HP BIOS supports the HP stable product roadmap by releasing only critical BIOS changes to the factory and advanced change notification.
- UEFI specification version 2.6
- Absolute Persistence agent For tracking and tracing services, available in select countries, separate software and purchase of a subscription is required.
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Workstation computer in any enterprise environment.
- Acoustic performance Industry leading acoustic emissions across the range of operating conditions.
- Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Workstation computers, including BIOS updates from within Windows (HP Firmware Update and Recovery), HP Client Manager, and fail-safe recovery. In addition, the HP BIOS Configuration Utility enables replication of BIOS settings within Windows while the Replicated Setup feature provides the same capability within BIOS (F10) Setup. The BIOS Configuration Utility is available from the HP support website.
- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.

Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the BIOS Setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS cannot be updated and changes cannot be made to BIOS settings using BIOS Setup or under the OS.
- S5 Maximum Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 0.5W in S5 (when turned off). When S5 Maximum Power Savings feature is enabled below features are turned off:
 - -Power to expansion connectors / slots
 - -Wake events other than power buttons (such as wake on LAN)
 - -USB charging ports

HP Sure Start Gen4 Start

- BIOS Integrity checking Sure Start protection ensures that only trusted BIOS code is
 executed and not rootkits, viruses and malware. Verification is done upon boot up, shutdown
 and while the system is on.
- Sure Start is set by default to automatically repair the BIOS if corrupted or compromised but is
 policy driven for better manageability. Start is set by default to automatically repair the BIOS
 if corrupted or compromised but is policy driven for better manageability.
- Protecting beyond BIOS Integrity checking and repair is extended to other data that should be protected such as network configuration parameters, platform specific information (i.e. system IDs), secure boot credentials, and other code the system needs to boot.

Supported Components

 Audit enabled – System Audit via Sure Start Event Logs capture data such as incident, repair date and time for troubleshooting and investigating

HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS

BIOS
HP BIOSphere Gen4¹⁷
HP DriveLock & Automatic DriveLock
BIOS Update via Network
Master Boot Record Security
Power On Authentication Authentication
Secure Erase ¹⁸
Absolute Persistence Module¹⁹
Pre-boot Authentication
HP Wireless Wakeup

Software

HP Hotkey Support - CMIT

Manageability Features

HP Driver Packs²²

HP System Software Manager (SSM)

HP BIOS Config Utility (BCU)

HP Client Catalog

HP Manageability Integration Kit Gen2²³

Client Security Software

HP Client Security Suite Gen425 including:

HP Security Manager²⁶ (including Credential Manager, HP Password Manager, HP Spare Key)

HP Device Access Manager

HP Power On Authentication Authentication

Microsoft Defender²⁷

Security Management

Secure Erase¹⁸

TPM 2.0 Embedded Security Chip shipped with Windows 10 (Common Criteria EAL4+ Certified)³²

SATA port disablement (viaBIOS)

RAID configurations³³

Serial, USB enable/disable (viaBIOS)

Power-on password (viaBIOS)

Setup password (viaBIOS)

Support for chassis padlocks and cable lock devices

Integrated hood sensor

HP Sure Click³⁷

HP Sure Start Gen430

HP Sure Run³⁵

HP Sure Recover³⁶

17. HP BIOSphere Gen4 features may vary depending on the Workstation platform and configurations requires 8th Gen Intel® processors.



Supported Components

18. Secure Erase for the methods outlined in the National Institute of Standards and Technology Special Publication 800-88. Supported on Workstation platforms with BIOS version F.03 or higher.

19. Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software. Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

- 22. HP Driver Packs not preinstalled, however available for download at http://www.hp.com/go/clientmanagement.
- 23. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html

- 25. HP Client Security Suite Gen 4 requires Windows and Intel® or AMD 8th generation processors.
- 26. HP Password Manager requires Internet Explorer or Chrome or FireFox. Some websites and applications may not be supported. User may need to enable or allow the add-on / extension in the internet browser.
- 27. Microsoft Defender Opt in and internet connection required for updates.
- 30. HP Sure Start Gen4 is available on HP Workstation products equipped with Intel® 8th generation processors
- 32. Firmware TPM is version 7.6. Hardware TPM is v2.0.
- 33. RAID configuration is optional and does require a second hard drive.
- 35. HP Sure Run is available on HP Workstation products equipped with 8th generation Intel® or AMD® processors.
- 36. HP Sure Recover is available on HP Workstations with 8th generation Intel® or AMD processors and requires an open, wired network connection. You must back up important files, data, photos, videos, etc. before using HP Sure Recover to avoid loss of data
- 38. HP Sure Click is available on select HP Workstation platforms and supports Microsoft® Internet Explorer and Chromium™. Check http://h20195.www2.hp.com/v2/GetDocument.aspx?docname=4AA7-0922ENW for all compatible platforms as they become available



System Technical Specifications

System Board

System Board Form

ATX 24.89 x 24.38 mm (9.8 x 9.6 inches)

Factor

Processor Socket Single LGA-1151

CPU Bus Speed DMI

Chipset Intel® PCH C246 Memory Expansion Slots 4 DDR4 memory slots

Memory Type Supported DDR4, UDIMM (Unbuffered), ECC& non-ECC

Non-Interleaved for single channel. Interleaved when both channels are populated. **Memory Modes**

Memory Speed Supported 2666MT/s DDR4 ECC available on data **Memory Protection**

64GB Maximum Memory

Memory Configuration

(Supported)

4GB, 8GB and 16GB non-ECC/4GB, 8GB and 16GB ECC unbuffered DIMMs are supported.

ECC and non-ECC memory DIMMs cannot be mixed on the same system.

NOTE: * Maximum memory capacities assume 64-bit operating systems, such as Genuine Windows® 10 Professional 64 bit, Red Hat Linux 64-bit. 32-bit Windows Operating Systems support up to 4 GB.

PCI Express Connectors

1 PCI Express Gen3 slot x16 mechanical/ x16 electrical (full height, full length)

1 PCI Express Gen3 slot x4 mechanical/x1 electrical (full height, full length)

1 PCI Express Gen3 slot x4 mechanical/ x4x1 electrical (full height, full length)

1 PCI Express Gen3 slot x16 mechanical/x4 electrical (full height, full length)

2 M.2 Storage (PCIe Gen3 x4)1

1 M.2 WLAN (PCIe Gen3 x1)

In the PCIe Gen3 (x16 electrical/x16 mechanical) slot, it intent to supported HP certified added in card.

Note1: M.2 storage supports compatible devices up to 110mm

Supported Drive Interfaces

Integrated (4) Serial ATA interfaces (6Gb/s SATA). One port SATA

can optionally be used for eSATA.

RAID 0 and 1 supported. Factory integrated RAID is Microsoft

Windows only. RAID 5 is supported by Software XOR.

Serial Attached SCSI None

NOTE: Requires identical hard drives (speeds, capacity, **Integrated RAID**

interface)

Integrated Graphics Intel® UHD Graphics 630 (on Core i3/i5/i7-8xxx processors):

Intel® Integrated Graphics P630 for Xeon processors

Based on Unified Memory Architecture (UMA) - a region of system memory is reserved and dedicated to the graphics

display.

Support for Microsoft DirectX 12. OpenGL 4.4 and OpenCL 2.0 on Intel® UHD Graphics P630;

3 DP 1.2 graphics ports integrated in motherboard; Supports up to three simultaneous displays across DP & DVI-D

outputs.

Max. resolution supported on DP 1.2 ports: 3840x2160

@60Hz



System Technical Specifications

Network Controller Integrated Ethernet PHY Connection I219LM. Management

capabilities: WOL, PXE 2.1 and AMT 12

External SATA (eSATA) 1 port eSATA capable (SATA 3)

IDE connector No **Floppy connector** No

Serial 1 internal header (requires optional Serial Port Adapter Kit)

2nd Serial Yes **HD Integrated Audio** Yes

USB Connector(s) Front 1 USB-A 3.0, 1 USB-A 3.0 Charging Data Port and 1 USB-C 3.1

Gen2 Charging Data Port (Optional).

Rear 4 USB-A 3.0, 2 USB-A 2.0, and 1 USB-C 3.1 Gen2 Charging

Data Port (Optional via Flex module).

Internal 1 USB 3.0 and 3 USB 2.0 ports available as 2 separate

2x6(3.0 x1,2.0 x1) and 1x6(2.0 x1) headers: one USB 3.0 SD

Card Reader.

HD Integrated Audio Yes
Flash ROM Yes
CPU Fan Header Yes

Chassis Fan Header 1 Rear System Chassis Fan Header

Front Control Yes

Panel/Speaker Header

CMOS Battery Holder - Yes

Lithium

Integrated Trusted Integrated TPM 2.0

Platform Module The TPM module disabled where restricted by law, i.e. Russia.

Power Supply Headers Yes
Power Switch, Power LED Yes
& Hard Drive LED Header

Clear Password Jumper Yes

Keyboard/Mouse USB or PS/2 (option)

Power Supply

System Technical Specifications

System Configuration	ns						
Z2 G4 TWR	Processor Info	1x Intel® Core™ i3-6100 3.7 3MB 51W CPU					
Configuration #1 (TBD)	Memory Info	4GB (1x 4GB) 2133 MHz [DR4 non-EC	C		
	Graphics Info	Intel® UHD Integrated Graphics 630					
	Disks/Optical/Floppy	1x SATA 500 GB 7.2k rpm/ 1x 9.5mm Slim ODD					
	PSU	280W 90%					
	Other						
Energy Consumption		115	VAC	230	VAC	100	VAC
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows long Idle (S0)	TE	3D	TE	3D	TE	3D
	Windows short Idle (S0)	TE	3D	TE	3D	ТЕ	3D
	Windows Busy Typ (S0)	TE	3D	TE	3D	TE	3D
	Windows Busy Max (S0)	TE	3D	TE	3D	TE	3D
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	TE	3D	TE	3D	TE	3D
Heat Dissipation		115	VAC	230	VAC	100	VAC
(Btu/hr)	h.u. 1	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled LAN Disable	
	Windows Idle (S0)	TBD TBD			TBD		
	Windows short Idle (S0)	TBD		TBD		TBD	
	Windows Busy Typ (S0)	TBD TBD		TBD TBD		TBD TBD	
	Windows Busy Max (S0) Sleep (S3)	TBD	עצ	TBD	עצ	TBD	עצ TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	-	BD TBB		100 3D		BD 188
Z2 G4 TWR	Processor Info	1x Intel® Core™ i5-6500 3.2 6MB 65W CPU					
Configuration #2 (TBD)	Memory Info						
ENERGY STAR® CERTIFIED	Graphics Info	8GB (2x 4GB) 2133 MHz DDR4 ECC					
	-	1x NVIDIA® Quadro® K2200 1GB Graphics					
	Disks/Optical/Floppy	2x SATA 1 TB 7.2k rpm/ 1x9.5mm Slim ODD					
	PSU	400W 92%					
	Other	<u> </u>		1		1	
Energy Consumption (Watts)			VAC	-	VAC		VAC
(watts)	Windows long Idle (S0)	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows short Idle (S0)			TBD		1	
		1	3D	1	3D	1	BD
	Windows Busy Typ (S0) Windows Busy Max (S0)		BD BD	TBD TBD		1	BD
	Sleep (S3)	TBD	עצ TBD	TBD	עצ TBD	TBD	BD TBD
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD
	Zero Power Mode (EuP)	+	3D	1	1 1 DD	1	BD TOD
Heat Dissipation	zero i ower mode (EdF)		VAC	1	VAC	1	VAC
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
	Windows Idle (S0)	-	BD	-	3D	-	BD



System Technical Specifications

	Windows short Idle (S0)	TE	3D	TE	3D	Т	3D	
	Windows Busy Typ (S0)	1	3D		3D	TBD		
	Windows Busy Max (S0)		3D		3D		3D	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD	
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD	
	Zero Power Mode (EuP)	TE	 BD	TE	' 3D	TI	BD	
Z2 G4 TWR	Processor Info	1x Intel® Xed	on® E3-1280v	v5 3.7 8MB 8	OW CPU			
Configuration #3 (TBD)	Memory Info	64GB (4x16GB) 2133 MHz DDR4 ECC						
	Graphics Info	1x NVIDIA® Quadro® M4000 8GB Graphics						
	Disks/Optical/Floppy	2x 512GB Z	Turbo Drive G	2 PCIe SSDs	/ 1x9.5mm SI	lim ODD		
	PSU	400W 92%						
	Other							
Energy Consumption		115 VAC 230 VAC		100 VAC				
(Watts)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows long Idle (S0)	TBD		TE	TBD		TBD	
	Windows short Idle (S0)	TBD		TE	3D	TBD		
	Windows Busy Typ (S0)	TBD		TE	3D	TBD		
	Windows Busy Max (S0)	TE	3D	TE	3D	TI	3D	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD	
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD	
	Zero Power Mode (EuP)	TE	3D	TE	3D	TBD		
Heat Dissipation		115	VAC	230	VAC	100	VAC	
(Btu/hr)		LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
	Windows Idle (S0)	TE	3D	TBD		TBD		
	Windows short Idle (S0)	TE	3D	TE	TBD TBD		3D	
	Windows Busy Typ (S0)	TE	3D	TBD		TBD		
	Windows Busy Max (S0)	TE	3D	TE	3D	TI	3D	
	Sleep (S3)	TBD	TBD	TBD	TBD	TBD	TBD	
	Off (S5)	TBD	TBD	TBD	TBD	TBD	TBD	
		TBD		TBD		TBD		

400W Wide Ranging, Active PFC, 92% Efficient;

Note: 280W 90% Efficiency wide-ranging, active PFC Power Supply option available in some countries.

The HP Z2 Tower G4 Workstation 400W PSU Efficiency Report can be found at this link:

System Technical Specifications

Operating Voltage Range 90-269 VAC **Rated Voltage Range** 100-240 VAC **Rated Line Frequency** 50-60 Hz **Operating Line Frequency** 47-66 Hz

Range

Rated Input Current 6A@100-240V

Heat Dissipation Typical: 444 btu/hr (112 kcal/hr)

Maximum: 1484 btu/hr (374 kcal/hr)

Yes, with Wake-on-LAN disabled: <2W in S5- Power Off

80mm x 80mm x 25mm 4-wire PWM **Power Supply Fan**

ENERGY STAR® certified Yes

(Config Dependent)

CECP Compliant @ 220V Yes

FEMP Standby Power

Compliant

Built-in Self Test (BIST) Yes LED

Surge Tolerant Full

Yes **Ranging Power Supply** (withstands power surges

up to 2000V)

Hood Lock Header Yes ErP Lot 6- Tier 1 Yes Compliance @ 230V (<1W

in S5- Power Off)

ErP Lot 6- Tier 2 Yes

Compliance @ 230V (<0.5W in S5- Power Off)

Declared Noise Emissions	(Entry-level, Mid-level, ar	nd High-end configurations; tested on floo	or)		
System Configuration	Processor Info	Intel® Core™i7-8700 3.2 26666 6C CPL	Intel® Core™i7-8700 3.2 26666 6C CPU		
(Entry level)	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM			
	Graphics Info	Intel® UHD			
	Disks/Optical	1 TB SATA 6Gb/s SSD / No Optical			
		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)		
	Idle	3.2	13		
	Hard drive Operating (random reads)	3.3	13		
System Configuration	Processor Info	Intel® Xeon® processor E-2136			
(Mid-level)	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM			
	Graphics Info	NVIDIA® Quadro® P4000 8GB			
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD) / No Optical		
Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)		
7779 and ISO 9296)	Idle	3.6	18		
	Hard drive Operating (random reads)	3.8	22		

System Technical Specifications

System Configuration	Processor Info	Intel® Core™ i7-8700K 3.7 2666 6C CP	J			
(High-end)	Memory Info	64GB DDR4-2666 nECC (4x16GB) RAM				
	Graphics Info	NVIDIA® Quadro® P4000 8GB				
	Disks/Optical	2 x 2TB SATA 7200 rpm 6Gb/s 3.5" HDD / No Optical				
Declared Noise Emissions (in accordance with ISO		Sound Power (LWAd, bels)	Deskside Sound Pressure (LpAm, decibels)			
7779 and ISO 9296)	Idle	3.5	18			
	Hard drive Operating (random reads)	3.7	21			

Environmental Requirements

Temperature Operating: 5° to 35° C (40° to 95° F)

Above 1524 m (5,000 feet) altitude, the maximum operating temperature is reduced by 1° C (1.8° F) for every 305 m (1,000 feet) increase in elevation

Non-operating: -40° to 60° C (-40° to 140° F)

Maximum rate of change: 10°C/hr

Humidity Operating: 10% to 85% RH, non-condensing, 35° C maximum wet bulb

Non-operating: 10% to 90% RH, non-condensing, 35° C maximum wet bulb

Maximum Altitude Operating (with Rotational Hard Drives): 3,048 m (10,000 feet)

Operating (with only Solid-State Drives): 5,000 m (16,404 feet)

Non-operating: 12,192 m (40,000 feet)

Maximum operating temperature is reduced as altitude increases. See

Temperature for details.

Shock (non-repetitive) Operating ½-sine: 40g, 2-3ms (~62 cm/sec)

Non-operating ½-sine: 160 cm/s, 2-3 ms (~105 g)

Non-operating square: 422 cm/s, 20 g

Vibration Operating random: 0.5 g (rms), 5-300 Hz, up to 0.0025 g²/Hz

Non-operating random: 2.0 g (rms), 5-500 Hz, up to 0.0150 g²/Hz

Physical Security and Serviceability

Access Panel Tool-less

Includes system board and memory information

Optical Drive Tool-less, except for Screw-In carrier

Hard Drives Tool-less Expansion Cards Tool-less

Processor Socket Tool-less, except for the processor heatsink **Blue User Touch Points** Yes, on tool-less internal chassis mechanisms

Color-coordinated Cables Yes

and Connectors

Memory Tool-less
System Board Screw-In

Dual Color Power and HD Yes LED on Front of Computer Configuration Record SW Yes Over-Temp Warning on Yes

Screen



System Technical Specifications

Restore CD/DVD Set Consists of an operating system DVD (OSDVD) and a driver DVD (DRDVD). OSDVD restores the original

> operating system, DRDVD will provide all drivers for the system. The DRDVD may also contain applications that originally shipped with the system for optional installation. Applications can also be obtained from HP.com. OSDVD and DRDVD are orderable with the system and available from HP

Support.

Dual Function Front Power Switch

Yes, causes a fail-safe power off when held for 4 seconds

Yes (optional): Locks side cover and secures chassis from theft **Padlock Support**

0.22-in diameter padlock loop at rear of system

Cable Lock Support Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft

3 mm x 7 mm slot at rear of system

Universal Chassis Clamp

Lock Support

Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows

multiple units to be chained together when used with optional cable

Threaded feature at rear of system

Solenoid Lock and Hood

Sensor

Yes (optional)

The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The

Sensor Kit detects when the access panel has been removed.

Rear Port Control Cover

Serial. USB. Audio.

Network. Enable/Disable

Port Control

Yes, locks rear IO cables to prevent cable theft

Yes, enables or disables serial, USB, audio, and network ports

Removable Media Write/Boot Control Yes, prevents ability to boot from removable media on supported devices (and can disable writes to

media)

Power-On Password

Yes, prevents an unauthorized person from booting up the workstation

Setup Password

Yes, prevents an unauthorized person from changing the workstation configuration

3.3V Aux Power LED on

System PCA

Yes

Yes

NIC LEDs (integrated)

(Green & Amber) **CPUs and Heatsinks**

A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be

removed. CPU removal is tool-less

Power Supply Diagnostic Yes

Front Power Button Yes, ACPI multi-function

Front Power LED Yes, white (normal), red (fault)

Front Hard Drive Activity Yes, white

LED

Front ODD Activity LED Yes **Internal Speaker** Yes

System/Emergency ROM

Flash Recovery

Chassis Fan

Recovers corrupted system BIOS.

Cooling Solutions Air cooled forced convection

Power Supply Fans 92mm x 92mm x 25mm 4-wire PWM (non-serviceable) **CPU Heatsink Fan** Mainstream (<=65W): 92 mm x 92 mm x 52.5 mm Performance (<=95W): 94mm x 100.2mm x 110mm

92mm x 92mm x 25mm 4-wire PWM (non-serviceable)

Memory Heatsink Fan Nο

System Technical Specifications

HP PC Hardware Diagnostics UEFI HP PC Hardware Diagnostics (UEFI) enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support.

Access Panel Key Lock ACPI-Ready Hardware Nο

Advanced Configuration and Power Management Interface (ACPI).

- Allows the system to wake from a low power mode.
- Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.

Integrated Chassis

Handles

Rear Recessed Handle; optional Optical Bay Front Handle available.

Power Supply Requires T15 Torx or flat blade screwdriver

PCI Card Retention Yes, rear (all), middle (optional), front (full-length cards with extender)

Flash ROM
Diagnostic Power Switch

LED on board

Yes Yes

Clear Password Jumper Yes
Clear CMOS Button Yes
CMOS Battery Holder Yes
DIMM Connectors Yes



System Technical Specifications

Social and Environmental Responsibility

& Declarations

Eco-Label Certifications This product is low halogen except for power cords, cables and peripherals. Service parts obtained after purchase may not be Low Halogen:

- ENERGY STAR® (energy-saving features available on selected configurations-Windows only)
- US Federal Energy Management Program (FEMP)
- China Energy Conservation Program
- IT ECO declaration

Batteries

The battery in this product complies with EU Directive 2006/66/EC

Battery size: CR2032 (coin cell) Battery type: Lithium Metal

The battery in this product does not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 40ppm by weight

Restricted Material Usage

This product meets the material restrictions specified in HP's General Specification for the Environment. http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/qse.pdf HP Inc. is committed to compliance with all applicable environmental laws and regulations, including the European Union Restriction of Hazardous Substances (RoHS) Directive. HP's goal is to exceed compliance obligations by meeting the requirements of the RoHS Directive on a worldwide basis.

Low Halogen Statement

This product is low halogen except for power cords, cables and peripherals, as well as the following customer-configurable internal components: Creative Recon3D PCIe Audio Card is not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

and Recycling

End-of-Life Management HP Inc. offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner. This product is greater than 90% recyclable by weight when properly disposed of at end of life.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

Living Progress Report http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

Eco-label certifications

http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html

Additional Information

- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC.
- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and IS01043.
- This product is >90% recycle-able when properly disposed of at end of life
- EPEAT Gold registered in the United States. See http://www.epeat.net for registration status in your country. EPEAT® registered where applicable. EPEAT registration varies by country. See http://www.epeat.net for registration status by country. Search keyword generator on HP's 3rd party option store for solar energy accessory at http://www.hp.com/go/options



System Technical Specifications

Packaging

HP Workstation product packaging meets the HP General Specification for the Environment at http://www.hp.com/hpinfo/globalcitizenship/society/gen_specifications.html

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment
- Does not contain ozone-depleting substances (ODS)
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed
- Maximizes the use of post-consumer recycled content materials in packaging materials
- All packaging material is recyclable
- All packaging material is designed for ease of disassembly
- Reduced size and weight of packages to improve transportation fuel efficiency
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards formatting

Packaging Materials

Internal

Cushions made from fabricated recycled expanded-polyethylene (EPE) or recycled expandedpolypropylene (EPP). May also be made from recycled molded paper-pulp (MPP).

External

Carton made from corrugated fiberboard with at least 35% recycled content.

Manageability

Technology (AMT) v12

Intel® Active Management An advanced set of remote management features and functionality which provides network administrators the latest and most effective tools to remotely discover, heal, and protect networked client systems regardless of the system's health or power state. AMT 12 includes the following advanced management functions:

- Support for configuration of Intel AMT 12.0 new capabilities
- No reset after provisioning
- Support changes to BIOS table 130
- Support for Microsoft Windows Server 2012 R2
- Support for New Microsoft SQL Server Versions including Standard and Enterprise editions
- Support for Intel SSD Prop 2500 Series
- Support for Intel Enterprise Digital Fence
- The Platform Discovery Utility can now discover these additional Intel products:
- Intel SSD Pro 2500 Series; Enterprise Digital Fence
- Intel Identity Protection Technology with One Time Password; Public Key Infrastructure; Multi **Factor Authentication**
- Intel Identity Protection Technology with Intel WiGig
- New Profile Editor and Profile Editor Plugin Interface
- New Required Permissions for Solutions Framework

Intel® vPro™ Technology

The HP Z2 Tower G4 Workstations support Intel® vPro™ technology when purchased with a vPro™ technology capable CPU: Intel® Xeon® E-2100 processor family or 8th Generation Intel® Core™ i5/i7 processors with Intel® VT-d/VT-x and Intel® TXT technology

Visit: http://ftp.hp.com/pub/caps-softpaq/cmit/HPIA.html

HP Image Assistant

System Software Manager

Visit: http://www.hp.com/go/ssm

System Technical Specifications

Service, Support, and Warranty

- Program to proactively communicate Product Change Notifications (PCNs) and CustomerAdvisories by email to customers, based on a user-defined profile.
- PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition.
- Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support



Stable & Consistent Offerings

As part of its commitment to hardware, software, and solution innovation, HP is proud to introduce this breakthrough platform configuration stability to HP Workstation customers. HP Stable & Consistent Offerings are built on the foundation of a carefully chosen set of hardware and software designed and tested to work with all HP Z Workstation platforms through their end of life. These components and their corresponding HP Workstation platform compatibility are outlined in this section. HP Stable & Consistent Offerings are available worldwide to all HP Workstation customers—no special programs, no additional cost—no kidding. Simply select your hardware and software components when you customize your HP Workstation and be assured that you'll be able to buy that same configuration throughout the lifecycle of the product.

Processors	Product #	Offering Intel® Xeon® E-2124 3.4 8M GT2 4C Intel® Xeon® E-2144 3.6 8M GT2 4C	
Hard Drives	Product #	Official	
nara prives	Product #	Offering	
		512GB M.2 TLC 1st SSD	
		1TB 7200 RPM SATA 1st HDD	
Graphics	Product #	Offering	
		NVIDIA® Quadro® P620 2GB 1st GFX	
		NVIDIA® Quadro® P1000 2GB 1st GFX	
		AMD Radeon Pro WX 3100 2GB 1st GFX	



Technical Specifications - Processors

Intel® Xeon® Xeon® processor E-2100 family

Intel® Xeon® E-2176G 6C 3.7/4.7 HT 80W CPU Intel® Xeon® E-2174G 4C 3.8/4.7 HT 71W CPU Intel® Xeon® E-2144G 4C 3.6/4.5 HT 71W CPU Intel® Xeon® E-2136 6C 3.3/4.5 HT 80W CPU Intel® Xeon® E-2126G 6C 3.3/4.5 nHT 80W CPU Intel® Xeon® E-2124G 4C 3.4/4.5 nHT 71W CPU

8th generation Intel® Core™ processor family

Intel® Xeon® E-2104G 4C 3.2/3.2 nHT 65W CPU

Intel® Core™ i7-8700K 3.7 2666 6C CPU

Intel® Core™ i7+8700K (Core i7 and 16GB Intel® Optane™ memory*,**) 3.7 2666 6C CPU

Intel® Core™ i7-8700 3.2 26666 6C CPU

Intel® Core™ i7+8700 (Core i7 and 16GB Intel® Optane™ memory*,***) 3.2 26666 6C CPU

Intel® Core™ i5-8600 3.1 2666 6C CPU

Intel® Core™ i5+8600 (Core i5 and 16GB Intel® Optane™ memory*,**) 3.1 2666 6C CPU

Intel® Core™ i5-8500 3.0 2666 6C CPU

Intel® Core™ i5+8500 (Core i5 and 16GB Intel® Optane™ memory*,**) 3.0 2666 6C CPU

8th generation Intel® Core™ i3/Pentium processor family

Intel® Core™ i3-8100 3.6 2400 4C CPU
Intel® Pentium® G5400 3.7 2400 2C CPU

*Intel® Optane™ memory (cache) is sold separately. Intel® Optane™ memory system acceleration does not replace or increase the DRAM in your system. Available for HP commercial desktops and notebooks and for select HP workstations (HP Z240 Tower/SFF, Z2 Mini, ZBook Studio, 15 and 17 G5) and requires a SATA HDD, 7th Gen or higher Intel® Core™ processor or Intel® Xeon® processor E3-1200 V6 product family or higher, BIOS version with Intel® Optane™ supported, Windows 10 version 1703 or higher, M.2 type 2280-S1-B-M connector on a PCH Remapped PCIe Controller and Lanes in a x2 or x4 configuration with B-M keys that meet NVMe™ Spec 1.1, and an Intel® Rapid Storage Technology (Intel® RST) 15.5 driver.

**16GB Intel® Optane™ memory Available Fall 2018



Technical Specifications - Hard Drives

SATA	Hard	Drives	for	HP
Work	statio	ons		

500GB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 500GB
Height 1 in; 2.54 cm
Width Media Diame

Media Diameter3.5 in; 8.9 cmPhysical Size4 in; 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 32MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average2 ms11 ms
Full Stroke21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

1TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 1 Terabyte (1000 GB)
Height 1 in: 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in: 10.17 cm

Interface Serial ATA (6.0Gb/s), NCQ enabled

Synchronous Transfer Up to 600 MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads,
includes controller
overhead, includingSingle Track
Average2 msTime (typical reads,
includes controller
overhead, including
Full Stroke21 ms

settling)

Rotational Speed 7,200 rpm **Logical Blocks** 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

2.0TB SATA 7200 rpm 6Gb/s 3.5" HDD Capacity 2TB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.17 cm

Interface Serial ATA (6.0 Gb/s), NCQ Enabled

Synchronous Transfer Up to 600MB/s

Rate (Maximum)

Buffer 64MB

Seek Time (typical reads, includes controller overhead, including Full Stroke 1.0 ms

1.0 ms

Average 11 ms

settling)

Rotational Speed 7,200 rpm

Logical Blocks 3,907,029,168

Operating Temperature 41° to 131° F (5° to 55° C)

(hp)

Technical Specifications - Hard Drives

1TB SATA 7200 rpm
6Gb/s 3.5" HDD
(Enterprise Class)

1TB
SATA
3.5"
AHCI

Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/yr **Annualized Failure Rate** <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

operation

Physical Size (Height) 1 in: 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in: 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Up to 600MB/s

Synchronous Transfer

Rate (Maximum)

Buffer 128MB

Seek Time (typical reads, **Single Track** 0.32ms includes controller **Average** 7.45ms overhead, including **Full Stroke** 14.2ms settling)

Operating Temperature

41° to 140° F (5° to 60° C)

Performance

Sequential Read up to 226MB/s **Sequential Write** up to 226MB/s

Enterprise Class Features High Reliability

4TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class)

4TB Capacity **Protocol** SATA 3.5" **Form Factor Controller AHCI** Reliability (MTBF) 2.0M hours **Rated Power On Hours** 8760/vr **Annualized Failure Rate** <0.62%

(based on Rated POH)

Rated for 24/7/365 YES

Operation

Physical Size (Height) 1 in; 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in; 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Up to 600MB/s

Synchronous Transfer

Rate (Maximum)

128MB

Buffer

Seek Time (typical reads, **Single Track** 0.7ms includes controller **Average** 8.5ms



Technical Specifications - Hard Drives

overhead, including **Full Stroke** 15.7ms

settlina)

Operating Temperature 41° to 131° F (5° to 55° C)

Performance Sequential Read up to 226MB/s Sequential Write up to 226MB/s

Enterprise Class Features High Reliability

6TB SATA 7200 rpm 6Gb/s 3.5" HDD (Enterprise Class

Capacity 6TB Protocol SATA 3.5" **Form Factor** Controller **AHCI** Reliability (MTBF)

2.0M hours **Rated Power On Hours** 8760/vr **Annualized Failure Rate** <0.44%

(based on Rated POH)

Rated for 24/7/365 Operation 8 8 1

YES

Physical Size (Height) 1 in: 2.54 cm Physical Size (Width) 4 in; 10.17 cm **Media Diameter** 3.5 in: 8.9 cm

Interface Serial ATA (6Gb/s), NCQ enabled

Synchronous Transfer Rate (Maximum)

Up to 600MB/s

Buffer 128MB

Seek Time (typical reads, **Single Track** 0.7ms includes controller Average 8.5ms overhead, including **Full Stroke** 15.7ms settling)

Operating Temperature 41° to 140° F (5° to 60°C)

Performance Sequential Read up to 226MB/s **Sequential Write** up to 226MB/s

Enterprise Class Features High Reliability

500GB SATA 7.2K SED SFF Capacity 500GB HDD

Buffer

0.275 in: 0.7 cm Height

Width **Media Diameter** 2.5 in; 6.36 cm **Physical Size** 2.75 in; 6.99 cm

Interface Up to 600MB/s

Synchronous Transfer 128MB

Rate (Maximum)

64MB

Seek Time (typical reads, **Single Track** 1ms includes controller Average 4.2ms overhead, including 25ms (typical)

Full Stroke settling)

Rotational Speed 7,200 rpm

Operating Temperature 32° to 140° F (0° to 60° C)

Technical Specifications - Hard Drives

HP Solid State Drives (SSDs) for Workstations

HP 256GB SATA 6Gb/s

SSD

Capacity 256GB

Height 0.28 in: 0.7 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 256GB SATA 6Gb/s

SED Opal 2 SSD

Capacity 256GB

Height 0.28 in: 0.7 cm Width **Physical Size** Interface 6Gb/s SATA

Synchronous Transfer Rate (Maximum)

Up to 550MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 512 GB SATA 6Gb/s

SSD

Capacity 512GB

Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 1TB SATA 6Gb/s SSD 1TB Capacity

> Height 0.28 in; 0.7 cm

Width **Physical Size** 2.5 in; 6.36 cm

Interface 6Gb/s SATA

Synchronous Transfer

Rate (Maximum)

Up to 500MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

HP 2TB SATA 6Gb/s SSD Capacity 2TB

> **Protocol SATA** Form Factor 2.5" Controller AHCI **NAND Type** 3D TLC

400TBW (TB Written) **Endurance**

Reliability (MTTF) 1.5M hours Physical Size (Height) 0.28 in; 0.7 cm Physical Size (Width) 2.5 in; 6.36 cm Interface SATA 6Gb/s

Synchronous Transfer

Rate (Maximum)

Up to 550MB/s (Sequential Read)

Operating Temperature 32° to 158° F (0° to 70° C)

Technical Specifications - Hard Drives

Performance	Sequential Read	530 MB/s
	Sequential Write	500 MB/s
	Random Read	92K 10PS
	Random Write	83K IOPS

PCIe SSDs for HP Workstations HP Z Turbo Drv G2 256GB Capacity
TLC PCIe SSD (Z2 MB)
Protocol

Capacity 256GB **Protocol** PCle

Form Factor M.2 in native slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 75TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800 MB/s

Sequential Write 320 MB/s (1100 MB/s

max/Turbo)

Random Read 250K IOPS **Random Write** 180K IOPS

HP Z Turbo Drv G2 512GB Capacity
TLC PCIe SSD (Z2 MB)
Protocol

Capacity 512GB Protocol PCIe

Form Factor M.2 in native slot on motherboard

Controller NVMe
NAND Type 3D TLC

Endurance 150TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 2800 MB/s

Sequential Write 660 MB/s (1600 MB/s

max/Turbo)

Random Read 260K IOPS
Random Write 260K IOPS

HP Z Turbo Drv G2 1TB TLC PCIe SSD (Z2 MB) Capacity 1TB Protocol PCIe

Form Factor M.2 in native slot on motherboard

Controller NVMe NAND Type 3D TLC

Endurance 300TBW (TB Written)

Reliability (MTBF) 1.5M hours

Interface PCI Express 3.0 x4 electrical x4 physical

Operating Temperature 32° to 158° F (0° to 70° C)

Performance Sequential Read 3000 MB/s

Technical Specifications - Hard Drives

Sequential Write 1150 MB/s (1700 MB/s

max/Turbo)

Random Read 360K IOPS
Random Write 330K IOPS

Intel® 905p Series AIC PCIe SSD

Intel® 9005p Series AIC 280GB PCIe SSD

Capacity 280GB Protocol PCIe

Form Factor PCIe Card, Half Height

Controller NVMe **NVM Type** 3DXPoint

Endurance 5.11 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 2730 MB/s

Sequential Write2280 MB/sRandom Read587K IOPSRandom Write559K IOPS

Intel® 905p Series AIC 480GB PCIe SSD Capacity 480TB Protocol PCIe

Form Factor PCIe Card, Half Height

Controller NVMe **NVM Type** 3DXPoint

Endurance 8.76 PBW (PB Written)

Reliability (MTBF) 1.6M hours

Operating Temperature 32° to 185° F (0° to 85° C)

Performance Sequential Read 27100 MB/s

Sequential Write2280 MB/sRandom Read582K IOPSRandom Write561K IOPS

Technical Specifications - Graphics

Integrated Intel® UHD Graphics (Z2 G4)

Form Factor Integrated in select Intel® Xeon® E, Intel® Core™ i7, and Intel® Core™ i5

processors.

Check specific platform specifications for selections.

Graphics Controller

Memory

Intel® UHD Graphics

Unified Memory Architecture (UMA) frame buffer. Graphics memory is

shared with system memory. Size selectable between 64 MB to 1024 MB via BIOS setting. Default size is 64 MB. Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (Intel® DVMT 5.0), to provide an optimal balance between graphics and system

memory use.

Connectors Check system platform specifications where Intel® UHD Graphics are

available.

Maximum Resolution Display Port: 4096 x 2160

DVI: 1920x1200 VGA: 2048x1536

NOTE: For DVI and VGA outputs, separate adapters may be required.

Shading Architecture

Shader Model 5.0 (It's under confirmation with Intel® for the latest version,

TBD)

Supported Graphics APIs

OpenGL 4.4 DirectX 12

Available Graphics

Drivers

Windows 10

NVIDIA® Quadro® P400 2GB Graphics

Form Factor

Dimensions: 2.713" H x 5.7" L

Single Slot, Low Profile

Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P400 Graphics Card

GP107-825 GPU 256 CUDA cores Max Power: 30 Watts

Bus Type PCI Express 3.0 x16
Memory Size: 2 GB GDDR5, 2

Size: 2 GB GDDR5, 2000 MHz Memory Interface: 64-bit Memory Bandwidth: 32 GB/s

Connectors 3mDP Outputs*

Maximum Resolution DisplayPort[™] 1.4:

- up to 3x 5120 x 2880 x 24 bpp @ 60Hz- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 3 mDP Connectors

Display Gatput Simble Connection

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12

Technical Specifications - Graphics

Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P400, P600 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Note 1: Two mDP-to-DP adapters will ship with each P400, P600 or P1000

configured in HP Z Workstations Compatibles.

Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July 2017.

 Two mDP-to-DP Adapters are included in the P400, P600 and P1000 AMO kits.

 If mDP-to-DP Adapters are needed, Adapters can be ordered separately:

2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P620 2GB Graphics Form Factor Low Profile:

2.713 inches in height × 5.7 inches in length

Graphics Controller NVIDIA® Quadro™ P620

GP107-825 GPU

Number of Cores: 512 CUDA® cores

Max. Power: 40W

Cooling Solution: Active fan heatsink

Bus TypePCI Express x16MemorySize: 2GB DDR5
Clock: 2400Mhz

Memory Bandwidth: 80GB/s

Connectors4 x mDP 1.4Maximum ResolutionDisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz

- supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Shading Architecture Shader Model 5.1
Supported Graphics APIs DX11, OpenGL 4.3
Available Graphics Windows® 8

Drivers Windows 7 Professional (64-bit and 32-bit)

Windows XP Professional (64-bit and 32-bit)

Linux®

Technical Specifications - Graphics

HP qualified drivers may be preloaded or the latest HP qualified drivers are available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

*P400, P620 and P1000 only have mini-DisplayPort™ (mDP) video ports. **Note 1:** Two mDP-to-DP adapters will ship with each P400, P620 or P1000 configured in HP Z Workstations Compatibles.

Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July 2017.

- Two mDP-to-DP Adapters are included in the P400, P620 and P1000 AMO kits.
- If mDP-to-DP Adapters are needed, Adapters can be ordered separately:
 - 2KW86A6 HP (Bulk 4) miniDP-to-DP Adapter Cables

2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

Form Factor

Low Profile:
 2.713 inches in height × 5.7 inches in length

AMD FirePro™ WX3100 2GB Graphics

Form Factor

Low Profile, half length (full-height bracket included)

Graphics Controller

AMD FirePro™ W2100 professional graphics based on Oland GPU. GPU: 320 Stream Processors organized into 5 Compute Units

GPU Frequency: 630Mhz

Power: 26W Cooling: Active

Bus Type PCI Express® x8, Generation 3.0

Memory 2GB DDR3 memory

Memory Bandwidth: up to 28.8 GB/s

Memory Width: 128 bit

Connectors 2x Display Port 1.2 connectors

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution

DisplayPort™ 1.2:

- up to 4096x2160 x 24 bpp @ 60Hz

Dual Link DVI(I) (requires adapter cable): - up to 2560 x 1600 x 32 bpp @ 60Hz

Single Link-DVI(I)(requires adapter cable): - up to 1920 x 1200 x 32 bpp @ 60Hz

VGA (requires adapter cable):

Technical Specifications - Graphics

- up to 1920 x 1200 x 32 bpp @ 60Hz

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color component.

High bandwidth scaler for high quality up and downscaling.

Display Output 2 x DisplayPort™ 1.2a

Maximum number of displays: 2

Shading Architecture Shader Model 5.0

Supported Graphics APIs OpenCL™ 1.2, DirectX® 11.2/12, OpenGL 4.4

OpenGL 4.4 support with driver release 14.301.xxx

OpenCL 1.2 conformance expected with drive release 14.301.xxx

Available Graphics Drivers Windows 8.1 (64-bit and 32-bit)

Windows 7 (64-bit and 32-bit)

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes Depending on the card model, native DisplayPort™ connectors and/or

certified DisplayPort™ active or passive adapters to convert your monitor's native input to your card's DisplayPort™ or Mini-DisplayPort™ connector(s)

may be required. See www.amd.com/firepro for details.

Radeon™ Pro WX 4100 4GB Graphics Form Factor

Low-Profile Single Slot (6.6" Length)

Graphics Controller

GPU: 1024 Stream Processors organized into 16 Compute Units

Power: 50 Watts Cooling: Active

Memory 4GB GDDR5 memory

Memory Bandwidth: 6 Gbps / 96 GB/s

Memory Width: 128 bit

Polaris 11 Baffin GL XT

Connectors 4x Mini DisplayPort™ 1.4 – HDR ready connectors with HBR3 and MST

support.

Factory Configured: Four mDP-to-DP cable adapters included After market option kit: Four mDP-to-DP cable adapters included

Additional DisplayPort[™]-to-VGA or DisplayPort[™]-to-DVI adapters are available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5K monitors

4x 4K support @ 60Hz

Technical Specifications - Graphics

Image Quality Features Advanced support for 8-bit and 10-bit per RGB color component. High

bandwidth scaler for high quality up and downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSync support

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX°12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

Available Graphics

Drivers

Windows 10 64-bit Windows® 7 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

 HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

2. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.

3. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P1000 4GB Graphics **Form Factor** Dimensions: 2.713" H x 5.7" L

Single Slot, Low Profile Cooling: Active Weight: 129 grams

Graphics Controller NVIDIA® Quadro® P1000 Graphics Card

GP107-860 GPU 640 CUDA cores Max Power: 47 Watts PCI Express 3 0 x16

Bus Type PCI Express 3.0 x16

Memory Size: 4 GB GDDR5, 2500 MHz
Memory Interface: 128-bit memory interface

Memory Bandwidth: 80 GB/s memory bandwidth

Connectors 4mDP Outputs*

Technical Specifications - Graphics

Maximum Resolution DisplayPort™ 1.4:

- up to 4x 5120 x 2880 x 24 bpp @ 60Hz - supports Multi-Stream Transport (MST)

Image Quality Features 10-bit internal display processing pipeline

10-bit scan-out support

Display Output 4 mDP Connectors

Shading Architecture Full Microsoft DirectX 12 Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulkan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute, OpenCL

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 8.1 Microsoft Windows 7

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes *P400, P620 and P1000 only have mini-DisplayPort™ (mDP) video ports.

Note 1: Two mDP-to-DP adapters will ship with each P400, P600 or P1000

configured in HP Z Workstations Compatibles.

Note 2: AMO kits for P400, P600, P1000 and Adapters will ship in July

2017.

Two mDP-to-DP Adapters are included in the P400, P600 and

P1000 AMO kits.

• If mDP-to-DP Adapters are needed, Adapters can be ordered

separately:

- 2KW86A6 - HP (Bulk 4) miniDP-to-DP Adapter Cables

- 2KW87A6 - HP (Bulk 12) miniDP-to-DP Adapter Cables

NVIDIA® Quadro® P2000 5GB Graphics

Form Factor

Dimensions: 4.4"Hx7.9"L

Single Slot Cooling: Active Weight: 260 grams

Graphics Controller NVIDIA® Quadro® P2000 Graphics Card

Power: 75 Watts

Bus Type PCI Express 3.0 x16

Memory Size: 5GB GDDR5

Memory Bandwidth: 140 GB/s Memory Width: 160-bit

Connectors 4x DisplayPort™ 1.4

Factory Configured Option: No adapter included with card After Market Option: No video cable adapter included

Technical Specifications - Graphics

Additional DVI to VGA, DisplayPort™ to VGA, DisplayPort™ to DVI, and DisplayPort™ to Dual-Link DVI adapters available as accessories.

Maximum Resolution

DisplayPort™:

- up to 5120 x 2880 x 24 bpp @ 60Hz

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST) DP 1.3

& 1.4 readv.

DL-DVI(I) output:

- up to 2560 x 1600 x 32 bpp @ 60 Hz

Single Link-DVI(I) output:

- up to 1920 x 1200 x 32 bpp @ 60Hz

HDMI 2.0 (requires DP to HDMI adapter):

5120 x 2880 x 24 bpp @ 60Hz

Image Quality Features

12-bit internal display pipeline (hardware support for 12-bit scanout on

supported panels, applications and connection)

Stereoscopic 3D display support including NVIDIA® 3D Vision™ technology.

NVIDIA® Mosaic and nView.

Display Output

Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available Ouadro® P2000 outputs

is 4.

Shading Architecture

Shader Model 5.1

Supported Graphics APIs OpenGL® 4.5

DirectX® 12

API support includes:

CUDA C. CUDA C++. DirectCompute 5.0. OpenCL. Java. Python, and Fortran

software

Available Graphics

Drivers

Microsoft Windows 10

Microsoft Windows 7 Professional 64bit

Linux - Full OpenGL implementation, complete with NVIDIA® and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

1. Quadro P2000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.

Quadro P2000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

Technical Specifications - Graphics

Radeon™ Pro WX 7100 8GB Graphics Form Factor
Graphics Controller

Full-Height Single Slot (9.5" Length) Radeon™ Pro WX 7100 graphics

GPU: 2304 Stream Processors organized into 36 Compute Units

Power: 130 Watts Cooling: Active

Memory 8GB GDDR5 memory

Memory Bandwidth: 7 Gbps / 224 GB/s

Memory Width: 256 bit

Connectors 4x Display Port 1.4 – HDR ready connectors with HBR3 and MST support.

Factory Configured: No video cable adapter included After market option kit: No video cable adapter included

Additional DisplayPort™-to-VGA or DisplayPort™-to-DVI adapters are

available as Factory Configuration or Option Kit accessories.

Maximum Resolution 5K support @ 60Hz

• 1x single-cable 5K monitor, or 2x dual-cable 5K monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 16-bit per RGB color

component. High bandwidth scaler for high quality up and

downscaling

Display Output 4 full physical DP1.3 HBR3 / DP1.4 HDR outputs

FreeSvnc support

GPU Architecture GCN 4th Generation

Supported Graphics APIs DirectX°12

OpenGL® 4.5 OpenCL™ 2.0 Vulkan™ 1.0

Available Graphics Drivers Windows 10 64-bit Windows® 7 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

4. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

5. Radeon VR Ready Creator Products are select Radeon Pro and AMD FirePro™ GPUs that meet or exceed the Oculus Rift or HTC Vive recommended specifications for video cards/GPUs. Other hardware (including CPU) and system requirements recommended by Oculus Rift or HTC Vive should also be met in order to operate the applicable HMDs

Technical Specifications - Graphics

- as intended. As VR technology, HMDs and other VR hardware and software evolve and/or become available, these criteria may change without notice.
- 6. AMD PowerTune and AMD ZeroCore Power are technologies offered by certain FirePro™ and Radeon™ Pro products, which are designed to intelligently manage GPU power consumption in response to certain GPU load conditions.
- 7. As of September 2016, certified for DisplayPort™ 1.4 HBR3 and ready for DisplayPort™ 1.4 HDR based on independent verification by DisplayPort™ testing authority. HDR content requires that the system be configured with a fully HDR-ready content chain, including: graphics card, monitor/TV, graphics driver and application. Video content must be graded in HDR and viewed with an HDR-ready player. Windowed mode content requires operating system support.

NVIDIA® Quadro® P4000 8GB Graphics Form Factor

Dimensions: 4.4"H x 9.5"L Single-slot, full-height

Weight: 475 grams (without extender)

Graphics Controller

NVIDIA® Quadro® P4000 Graphics Card GPU: GP104 with 1792 CUDA cores

Power: 120 Watts

Bus Type Memory PCI Express 3.0 x16 Size: 8GB GDDR5

Memory Bandwidth: 243 GB/s Memory Width: 256-bit

Connectors

4 x DisplayPort™ 1.4

3-pin mini-DIN connector via optional bracket

1 x 6-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II

2 x SLI connectors

Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included

Additional DisplayPort™-to-VGA, DisplayPort™-to-HDMI, or DisplayPort™-to-DVI adapters are available as accessories

Maximum Resolution

Dual-link internal TMDS (DVI 1.0): - up to 2560 x 1600 x 32 bpp @ 60 Hz

Single-link internal TMDS (DVI 1.0): - up to 1920 x 1200 x 32 bpp @ 60 Hz

HDMI[™] 2.0b (requires DP to HDMI adapter): - up to 5120 x 2880 x 24 bpp @ 60Hz

DisplayPort™:

- up to 4096 x 2160 x 30 bpp @ 60Hz- up to 2560 x 1600 x 30 bpp @ 120 Hz

Technical Specifications - Graphics

- supports High Bit Rate 2 (HBR2) and Multi-Stream Transport (MST)

Using two DP outputs, the P4000 can drive one dual DP input display with

5120 x 2880 x 30 bpp @ 60Hz resolution.

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color

component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies

NVIDIA® Mosaic and nView

Display Output Maximum number of displays

- 4 direct attached monitors

Maximum number of monitors across all available Quadro P4000 outputs

is 4.

Shading Architecture Shader Model 5.1

Supported Graphics APIs OpenGL 4.5

DirectX 12 Vulcan 1.0

API support includes:

CUDA C, CUDA C++, DirectCompute 5.0, OpenCL, Java, Python, and Fortran

Available Graphics

Drivers

Microsoft Windows 10 Microsoft Windows 7

Linux - Full OpenGL implementation, complete with NVIDIA® and ARB

extensions

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Notes

1. Quadro P4000 offered as Factory Configured Option does not include a video cable adapter. Video cable adapters must be ordered separately.

2. Quadro P4000 offered as an After Market Option does not include video cables. Video cable adapters must be ordered separately.

NVIDIA® Quadro® P5000 **8GB Graphics**

Form Factor Dimensions: 4.4"H x 10.5"L

> Dual-slot, full-height Weight: 815 grams

NVIDIA® Quadro® P5000 Graphics Card **Graphics Controller**

GPU:: 2560 NVIDIA® CUDA® cores

Bus Type PCI Express 3.0 x16 Size: 16GB GDDR5 Memory

> Memory Bandwidth: 288 GB/s Memory Width: 256-bit

ECC memory (disabled by default)

4 x DisplayPort™ 1.4 (HDR support) **Connectors**

DL-DVI(D)

Technical Specifications - Graphics

3-pin mini-DIN connector via optional bracket

1 x 8-pin auxiliary power connector 4-pin header for stereo signal SYNC connector for Quadro® Sync II

2 x SLI connectors

Factory Configured Option: No video cable adapter included After Market Option: No video cable adapter included

Additional DisplayPort™-to-VGA, DisplayPort™-to-HDMI, or DisplayPort™-

to- DVI adapters are available as accessories

Maximum Resolution 5K support @ 60Hz

1x single-cable 5K monitor, or 2x dual-cable 5k monitors

Image Quality Features Advanced support for 8-bit, 10-bit, and 12-bit per RGB color component.

HDCP 2.2 support over DisplayPort™, DVI, and HDMI connectors

NVIDIA® 3D Vision™ and other 3D stereo technologies NVIDIA® Mosaic and nView Desktop Management

Supported Graphics APIs DirectX®12, OpenGL® 4.5, OpenCL™ 1.0, Vulkan™ 1.0 Developer API

support includes: CUDA C, CUDA C++, DirectCompute 5.0, OpenCL™, Java,

Python, and Fortran

Available Graphics

Drivers

Windows 10 64-bit Windows® 7 64-bit

Linux®

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html



Technical Specifications - Optical and Removable Storage

HP 9.5mm Slim DVD Writer

Description 9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 128 x 9.5 x 127mm

Supported Media Types DVD+R

DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Access Times Full Stroke DVD < 200 ms (seek)

Full Stroke CD < 200 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD+RW Up to 8X

> DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -< 800 mA typical, <1600 mA maximum

Operating Environmental Temperature

(all conditions noncondensing)

41° to 122° F (5° to 50° C)

Relative Humidity 10% to 80%

Temperature

Maximum Wet Bulb

Operating Systems

Supported

Windows 10, Windows 7 Professional 32-bit and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

84° F (29° C)

Home 32*. Linux®

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents HP SATA DVD Writer drive, installation guide.

HP 9.5mm Slim DVD-ROM Description

Drive

9.5mm height, tray-load **Mounting Orientation** Either horizontal or vertical

Interface Type SATA / ATAPI

Technical Specifications - Optical and Removable Storage

Dimensions (WxHxD) 128 x 9.5 x 127mm

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB

Double layer: Up to 8.5 GB

Access Times DVD-ROM Single Layer < 110 ms (typical)

> **CD-ROM Mode 1** < 110 ms (typical) **Full Stroke DVD** < 230 ms (typical) **Full Stroke CD** < 220 ms (typical)

Power Source SATA DC power receptacle

> **DC Power Requirements** $5 \text{ VDC} \pm 5\%-100 \text{ mV ripple p-p}$

5 VDC - <800mA typical, < 1600 mA maximum **DC Current**

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity 10% to 80% **Maximum Wet Bulb** 84° F (29° C)

Temperature

Operating Systems Supported

Windows 10. Windows 7 Professional 32-bit and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*. Windows 2000. Windows XP Professional or Windows XP

Home 32*. Linux®

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim DVD-ROM Drive, slim SATA data/power cable, installation

quide

HP 9.5mm Slim BDXL Blu- Description **Ray Writer**

9.5mm height, tray-load Either horizontal or vertical

Mounting Orientation Interface Type

SATA/ATAPI

Dimensions (WxHxD)

128 x 9.5 x 127mm

Supported Media Types

BD-ROM BD-R

> **BD-RE DVD-RAM** DVD+R DVD+RW DVD+R DL DVD-R DL DVD-R DVD-RW

CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

Blu-ray

25 GB (single-layer) 50 GB (dual-layer) 100/128 GB (BDXL)

Full Stroke DVD

< 230 ms (seek)

Access Times

Full Stroke CD < 220 ms (seek)



Technical Specifications - Optical and Removable Storage

< 230 ms (seek) (Full Stroke Blu-ray) Blu-rav

Startup Time (Time to drive ready from tray loading)

BD-ROM (SL/DL) 25S / 28S BD-R (SL/DL) 255 / 285 BD-RE (SL/DL) 255 / 285 DVD-ROM (SL/DL) 18S / 18S DVD-R (SL/DL) 255 / 255

DVD-RW **25S**

DVD+R (SL/DL) 25S / 25S

DVD+RW 255 **DVD-RAM 45S** CD-ROM **15S**

Maximum Data Transfer CD ROM Read

Rates

CD-ROM, CD-R Up to 24X

CD-RW Up to 24X

DVD ROM Read DVD-RAM Up to 8X

> DVD+RW Up to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 8X DVD-ROM DL Up to 8X DVD+R Up to 8X DVD-R Up to 8X

Blu-ray BD-ROM Up to 6X

> BD-ROM DL Up to 6X BD-R Up to 6X BD-R DL Up to 6X Up to 6X BD-R BD-RE SL/DL Up to 6X

Power Source SATA DC power receptacle

> **DC Power Requirements** 5 VDC ± 5%-100 mV ripple p-p

DC Current 5 VDC -900 mA typical, 2000mA maximum

10% to 80%

Operating Environmental Temperature

(all conditions noncondensing)

Relative Humidity

41° to 122° F (5° to 50° C)

Maximum Wet Bulb 84° F (29° C)

Temperature

Operating Systems Supported

Windows 8.1, Windows 8 32-bit and 64-bit, Windows 7 Professional 32-bit

and 64-bit.

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*. Linux®

No driver is required for this device. Native support is provided by the

operating system.

Kit Contents 9.5mm Slim BDXL Blu-Ray Writer, 5.25" ODD Bay adapter/carrier, slim SATA

data/power cable, installation guide

NOTES As Blu-ray is a new format containing new technologies, certain disc, digital

connection, compatibility and/or performance issues may arise, and do not

Technical Specifications - Optical and Removable Storage

constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

HP SD Media Card Reader Description

USB3.0-SD4.0

Interface Type

- Support USB 2.0 LPM function
- Support USB 3.0 U1/U2/U3 Power saving mode
- Support USB 3.0 LTM function.

Dimensions (WxHxD) Supported Media Types

Dedicated slot in front bezel (orderable option)

- Secure Digital Card (SD)
- ii. Secure Digital Support up to 2TB
- iii. Secure Digital HC (SDHC)
- iv. Secure Digital XC (SDXC)
- Support SD USH50 mode ٧.
- vi. miniSD *1
- vii. miniSDHC*1
- viii. MicroSD*1
- ix. MicroSDHC*1 MicroSDXC*1
 - Note: "*1" means Adapter Needed

Operating Systems Supported

No driver is required for this device. Native support is provided by the operating system.

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

See http://www.microsoft.com/windows/windows-7/ for details.

HP DX115 Removable Drive Enclosure

Interface Type

Compatible with SATA or SAS controllers. Offers 6Gb/s performance when

used with 6Gb/s HDDs.

Dimensions (WxHxD) 14.76 cm x 4.11 cm x 20.5 cm

(5.81in x 1.62 in x 8.08 in)

Weight Frame and Carrier: 1.73 kg (3.8 lbs)

Carrier: 0.45 kg (1 lbs)



Technical Specifications - Controller Cards

HP Thunderbolt™ 3 PCIe Data Transfer Rate
3-port I/O Card Devices Supported

Data Transfer RateSupports up to 40 Gb/s 40,000 Mb/s)Devices SupportedThunderbolt™ certified devices

Bus Type PCIe card, full or half height PCIe slots
Ports One USB 3.1 Type-C connector (Rear)

Internal Connectors One 60-pin board-to-board (FlexIO) connector

System Requirements Windows 10 RS3 64-bit, Intel® i5 series or higher processor, 4-GB RAM, 20-

GB Hard Drive, available PCIe slot.

Temperature - Operating 50° to 131° F (10° to 55° C) **Temperature - Storage** -22° to 140° F (-30° to 60° C)

Relative Humidity - 20% to 80% Operating

Compliances FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998 STD,

Taiwan BSMI CNS13438, Korea MIC

-Windows 10 RS3 64-bit.

Operating Systems

Kit Contents

Supported

HP Thunderbolt™ 3 PCIe 3-port I/O Card, full height and half height bulkhead bracket, DisplayPort™ and GPIO (General-Purpose Input/Output) cable, FlexIO adapter board, Installation documentation and warranty card.



Technical Specifications - Networking and Communications

Integrated Intel® I219LM Connector **PCIe GbE Controller** (Intel® vPro™ with Intel® **AMT 12.0)**

RI-45

Controller Intel® I217LM GbE platform LAN connect networking controller

Memory 3 KB Tx and 3KB Rx FIFO packet buffer memory

Data Rates Supported 10/100/1000 Mbps

Compliance 802.1as/1588, 802.1p, 802.10, 802.3, 802.3ab, 802.3az, 802.3i, 802.3u,

802.3z

Bus Architecture PCI Express and SMBus

Data Transfer Mode PCIe-based interface for active state operation (SO state) and SMBus for

host and management traffic (Sx low power state)

Requires 3.3V (integrated regulators for core Vdc) **Power Requirement**

Boot ROM Support Yes

Network Transfer Mode Full-duplex; Half-duplex (not supported for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Management Capabilities vPro, WOL, auto MDI crossover, PXE, Muti-port teaming, RSS, ACPI.

Advanced cable diagnostic, loopback modes.

AMT 12.0 support, Circuit Breaker, VLAN, Multicast Listener Discovery

(MLD)

Intel® X710-DA2 2-Port SFP+ 10GbE NIC

Connector 2 SFP+ Ports

Cabling Twin Axial Cabling up to 10m

Controller Intel® Ethernet Controller X710-AM2

Network Transfer Rates

Supported

10GbE (with supported 10GBASE-SR transceivers)

Data Path Width PCIe Gen3x8 (compatible with x4)

Power Requirement 4.3W (typical) (with supported 10GBASE-SR transceivers)

Operating Temperature 32° to 131° F (0° to 55° C) **Dimensions** (HxW) 2.703 x 6.578 inches **Operating System Driver** Windows 10 64-bit

Support Linux®

Kit Contents Intel® X710-DA2 2-Port SFP+ 10GbE NIC with standard height bracket

attached

Low-profile bracket

Product Literature

HP 10GbE SFP+ SR Transceiver

Operating Temperature 32°F to 113°F (0°C to 45°C) **Operating Humidity** 0% to 85%, noncondensing **Dimensions** (HxWxD) 0.47 x 0.54 x 2.19 inches

Technical Specifications - Networking and Communications

Kit Contents HP 10GbE SFP+ SR Transceiver

Intel® X550-T2 2-Port **10GbE NIC**

Connector 2 RJ-45

Cabling 10GbE: Cat6a (or better) up to 100m

5GbE and below: Cat5e (or better) up to 100m

Controller Intel® Ethernet Controller X550 **Network Transfer Rates** 10GbE, 5GbE, 2.5GbE, 1GbE, 100MbE

Supported

Data Path Width PCIe Gen3x4 **Power Requirement** 11.2W (typical)

Operating Temperature 32° to 131° F (0° to 55° C) **Dimensions** (HxW) 5.1 x 2.7 in (without brackets)

Operating System Driver Windows 10 64-bit

Linux®

Support **Kit Contents**

Intel® X550-T2 2-Port 10GbE NIC with standard height bracket

attached

Low-profile bracket **Product Literature**

Aguantia® AQN-108 1-Port 5GbE NIC

Connector 1 RJ-45

Cabling Cat5e (or better) up to 100m

Controller Aquantia® AQC108

Network Transfer Rates

Supported

5Gbe, 2.5GbE, 1GbE, 100MbE

Data Path Width PCIe Gen3x1 3.5W (typical) **Power Requirement**

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 3.72 x 3.18 inches (without brackets) **Operating System Driver** Windows 7 64-bit; Windows 10 64-bit;

Support

Kit Contents

Linux®

Aguantia AQN-108 1-Port 5GbE NIC with standard height bracket

attached

Low-profile bracket **Product Literature**

Intel® I350-T2 2-Port **1GbE NIC**

Connector 2 RJ-45

Cabling Cat5e (or better) up to 100m Controller Intel® Ethernet I350 Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

Data Path Width PCIe Gen2.1x4 4.4W (typical) **Power Requirement**

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 2.75 x 5.5 inches (without brackets)



Technical Specifications - Networking and Communications

Support

Operating System Driver Windows 7 64-bit; Windows 10 64-bit;

Linux®

Kit Contents Intel® 1350-T2 2-Port 1GbE NIC with standard height bracket attached

Low-profile bracket

Product Literature

Intel® I350-T4 4-Port **1GbE NIC**

Connector 4 RJ-45

Cabling Cat5e (or better) up to 100m **Controller** Intel® Ethernet I350 Controller

Network Transfer Rates

Supported

1GbE, 100MbE, 10MbE

Data Path Width PCIe Gen2.1x4 **Power Requirement** 5W (typical)

Operating Temperature 32° to 131° F (0° to 55° C)

Dimensions (HxW) 2.75 x 5.5 inches (without brackets) **Operating System Driver** Windows 7 64-bit; Windows 10 64-bit; Linux®

Support

Kit Contents

Intel® I350-T4 4-Port 1GbE NIC with standard height bracket attached

Low-profile bracket **Product Literature**

Intel® 9560 802.11ac, BT WLAN Standards

5. M.2

802.11a/b/g/n/ac, 802.11d, 802.11e, 802.11h, 802.11i, 802.11w, 802.11r,

802.11k, 802.11v

802.11ac Wave 2 (up to 1.73Mbps, 160MHz Channels, MU-MIMO)

Antenna 2x2 Dual-Band

Bluetooth Standards

5

Operating Temperature 32° to 131° F (0° to 55° C)

Interface M.2 CNVio **Dimensions** M.2 2230 **Kit Contents** Not Available

HP Power Cord Kit HP Serial Port Adapter DM293A

PA716A

GM110AA

HP eSATA PCI Cable Kit

Part Number

Features

2x eSATA ports

Bring the same ultra-fast SATA performance that you demand from your internal SATA hard drives to an external eSATA hard drive.

Faster transfer rates than existing external storage solutions: USB 2.0 & 1394.

- Complete motherboard to eSATA PCI bracket solution.
- Robust and user friendly external eSATA connector.

Part Number M6W77AA

Technical Specifications - Networking and Communications

Z2 G4 TWR Bezel w/ Dust Overview Filter option

Workstations are deployed in a variety of different ways and in different environments, from under a desk to manufacturing floors, HP Workstations designed a dust filter option to further protect the system against the ingress of dust and other particles over the life of the system. Test have shown a reduction of dust ingress of up to 47% for the HP Z2 Tower G4 Workstation platform and is cleanable and serviceable by customers. There is also a BIOS setting that will warn customer when it is time to check and clean their filters.

Cleaning and servicing the dust filter

- After removing the filter from the system bezel (dust filter can be removed without the use of tools from the front bezel), either blow it with and wash with water or use a delicate duster (feather duster)to brush off the filter then rinse it with water.
- 2. Allow the filter half a day to dry at room temperature (25C at 30%-50% humidity)
- 3. Temperature of water can be 0-70C, due to the dust filter meeting the SQTM 70C humidity test. Suggested water temperature for best user experience is 0-50C.
- Normal tap water (and most other types of water) can be used to rinse the filter. Any type of corrosive liquid is restricted.

Enabling the Check Filter warning in the BIOS:

- Customers must enable the BIOS setting once they receive their
- 2. To enable, do the following once you see the boot screen for your system: F10 > Advanced > Built-In Device Options > Dust Filter
- Select to enable the Dust Filter replacement reminder, which can be set for 15, 30, 60, 90, 120, or 180 days. The Reminder will show during POST after the reminder timer has expired.

4.

NOTE: customers who anticipate more dust ingress in their environments should set the reminder for a shorter window. Customers anticipating longer ingress can set the reminder for a longer window.

BIOS Warnings

Large enterprise customers deploying multiple systems can centrally enable/control the BIOS warning using the WMI/BCU tool remotely to set the options below:

Dust Filter

- Disable*
- Enable

Dust Filter Reminder (Days)

15, 30, 60*, 90, 120, and 180

Z2 G4 Dust Filter (Filter Only)

Part Number

T9W48AA

This is intended to be a replacement filter for the HP Z2 Tower G4 Workstation in the event that the original filter would need to be replaced.

HP Z2 Tower G4 Workstation Front Card Guide Kit

Part Number Features

This front card guide kit is required to enable added mechanical stability when configuring select graphics cards on the HP Z2 Tower G4

Workstation.

The kit enables added mechanical stability when configuring:

3x NVIDIA® NVS NVS 310 or NVS 315 graphics cards



M6W78AA

Technical Specifications - Networking and Communications

- 2x NVIDIA® NVS 510 graphics cards
- 1x NVS 310 plus 1x NVS 510 graphics cards
- 2x AMD W2100 graphics cards
- 1x NVIDIA® Quadro® M4000, M5000 graphics cards
- 1x AMD FirePro W7000 graphics card



Technical Specifications – Miscellaneous Features

MISCELLANEOUS FEATURES

Management Features

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
 Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel® Wired for Management support; industry wide initiative to make Intel® architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

Serviceability Features

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
 - Power LED will blink red 2 to 5 times, then blink white 2 or more times, then repeat (with beep tones for each blink initially):
 - 2 red + 2 white User must provide file for BIOS recovery (USB storage typically)
 - 2 red + 3 white User must enter a key sequence to proceed with recovery by policy
 - 2 red + 4 white BIOS recovery is in progress
 - 3 red + 2 white Memory could not be initialized
 - 3 red + 3 white Graphics adaptor could not be found
 - 3 red + 4 white Power supply failure / not connected
 - 3 red + 5 white Processor not installed
 - 3 red + 6 white Current processor does not support an enabled feature
 - 4 red + 2 white Processor has exceeded its temperature threshold / system thermal shutdown
 - 4 red + 3 white System internal temperature has exceeded its threshold
 - 5 red + 2 white System controller firmware is not valid
 - 5 red + 3 white System controller detected BIOS is not executing
 - 5 red + 4 white BIOS could not complete initialization / PCA failure
 - 5 red + 5 white
 System controller rebooted the system after a health or recovery timer triggered
- HP PC Hardware Diagnostics UEFI:
 - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Color coordinated cables and connectors
- Tool-less Hood Removal
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- Tool-less Hard Drive, CD & Diskette Removal
- Green Pull Tabs, and Quick Release Latches for easy Identification



Summary of Changes

Date of change:	Version History:		Description of change:
July 23, 2018	From v1 to v2	Added	AMD FirePro™ WX3100 2GB Graphics specs
July 30, 2018	From v2 to v3	Change	Number of supported cards for Nvidia P620 changed to 1



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